

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			SERIAL NO.	GROUP/ART UNIT	ATTACHMENT TO PAPER NUMBER			
			08/660,016	2304				
NOTICE OF REFERENCES CITED			APPLICANT(S) Jack Pippin					
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*	DOCUMENT NO.	DATE	NAME	CLASS	SUB-CLASS	FILING DATE IF APPROPRIATE		
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S	Salminen et al. "The Higher Order Temperature Compensation of Bandgap Voltage References," IEEE, 1992, pp. 1388 - 1391.							
T	Ferro et al. "A Floating CMOS Bandgap Voltage Reference for Differential Applications," IEEE, 1989, pp. 690 - 697.							
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EXAMINER		DATE						
Vuthe Siek		12-31-96						
* A copy of this reference is not being furnished with this office action. (See Manual of Patent Examining Procedure, section 707.05 (a).)								